Shoulder 好达

SHOULDER ELECTRONICS CO., LTD.

CERAMIC RESONATOR Data Sheet

PRODUCT 产品: CERAMIC RESONATOR

MODEL NO 型 号: ZTTCC....MG

PREPARED 编 制: Fengyu

CHECKED 审 核: York

APPROVED 批 准:

DATE 日期: 2007-01-25

1. Scope

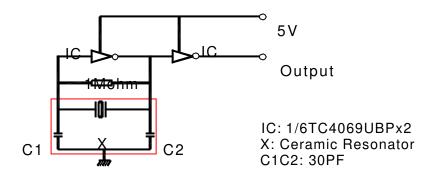
The specification is fit for ceramic resonator 1.84-8.00MHz.

2. Part NO: ZTTCC ..MG

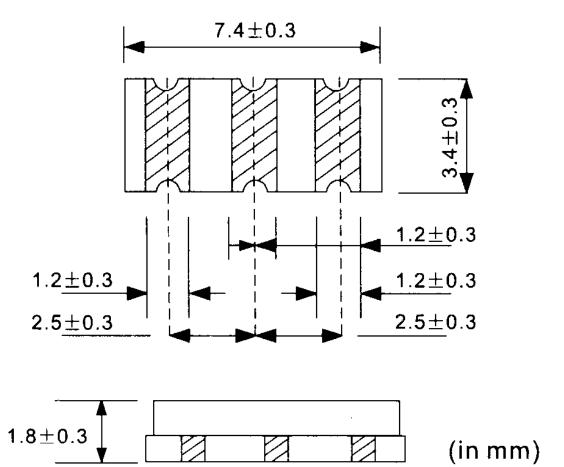
3. Electrical Characteristics

No.	Item	Characteristics				
3-1	Oscillate Frequency (MHz)	1.84-8.00				
3.2	Frequency Tolerance max	±0.5%				
3.3	Resonant Impedance $\max{(\Omega)}$	100				
3.4	Built – in Capacitance (PF)	30				
3.5	Insulate Resistance min (M Ω)	100				
3.6	Withstanding Voltage D.C (V)	100 (max 5 sec)				
3.7	Voltage (1) D.C Voltage max (V) (2) Input Voltage max (V)	6 15Vp-p				
3.8	Temp characteristics of Oscillate frequency max	±0.3%				
3.9	Operating Temp Range (℃)	-20 ~ +80				
3.10	Storage Temp (℃)	-55 ~ +85				

4. Test Circuit



5. Dimension



6. Physical and Environmental Characteristics

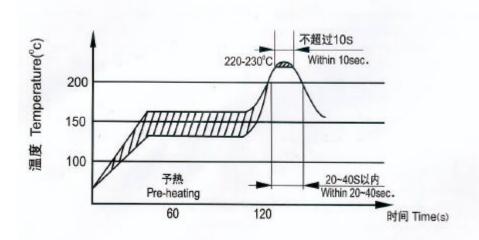
No	Item	Condition of Test	Performance			
			Requirements			
6.1	Humidity	Keep the resonator at 40±2 [®] C and 90-95% RH for 96 ± 4 hours. Then release the resonator into the room condition for 1 hour prior to the measurement.	It shall fulfill the specifications in Table 1.			
6.2	Vibration	Subject the resonator to vibration for 2 hours each in x,y and z axis with the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10-55Hz	It shall fulfill the specifications in Table 1.			
6.3	Mechanical Shock	Drop the resonator randomly onto a concrete floor from the height of 100 cm 3 times.	It shall fulfill the specifications in Table 1.			
6.4	Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1 hour before measurement.	It shall fulfill the specifications in Table 1.			

		Temperature at surface of the substrate Preheat 150±5℃ Peak 240±5℃	Time 60±10 sec. 10±3 sec.			
6.5	Solder Ability	Dip the resonator solder bath at 230	More than 95% of the terminal surface shall be covered.			
6.6	High Temperature Exposure	Subject the resona ±4 hours. Then rinto the room cond to the measuremen	It shall fulfill the specifications in Table 1.			
6.7	Low Temperature	\pm 4 hours. Then r	for to -20 ± 5 °C for 96 release the resonator itions for 1 hour prior t.	It shall fulfill the specifications in Table 1.		
6.8	Temperature Cycling	minutes followed b of 85℃ for 30 m repeated 5 times w	ator to -20℃ for 30 y a high temperature in. Cycling shall be with a transfer time of room condition for 1 easurement.	It shall fulfill the specifications in Table 1.		

TABLE1

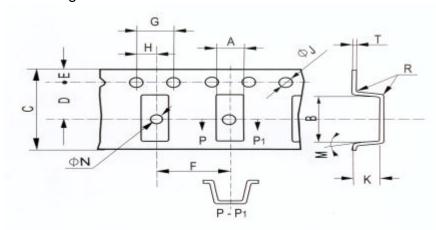
Item	Specification				
Oscillation Frequency Change	∆F/Fo≤0.3% max				
Resonant Impedance	∆Ro≼±10 Ohm				

RECOMMENDED REFLOW SOLDERING STANDARD CONDITIONS



7.

8. Packing



Tape Dimension (mm)

	A ±0.2	B ±0.2	C ±0.3	D ±0.1	E ±0.1	F ±0.1	G ±0.1	H ±0.1	ØJ ±0.1	ØN ±0.1	M max	R max	K ±0.2	T ±0.1
MG	3.8	7.8	16.0	7.5									2.1	
MT	5.0	4.4	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.6	10 "	0.3	1.8	0.3
MX	3.4	4.0	12.0	5.5									1.3	

Standard Package: 4Kpcs / reel